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<p>1. Name of conveying parties: (List using letters or numbers for multiple parties)</p> <p>a) Eui-Hoon Hwang b) Sang-Gul Lee</p> <p>Additional name(s) of conveying party(ies) attached? () Yes (X) No</p>	<p>2. Name and address of receiving party(ies):</p> <p>Name: Samsung SDI Co., Ltd. Internal Address: Street Address: 575 Shin-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea</p> <p>Additional name(s) of receiving party(ies) attached? () Yes (X) No</p>
<p>3. Nature of conveyance:</p> <p>(X) Assignment () Security Agreement () Merger () Change of Name () Other:</p> <p>Execution Date: (List as in section 1 if multiple signatures)</p> <p>a) June 21, 2006 b) June 21, 2006</p>	<p>4. US or PCT Application number(s) or US Patent number(s):</p> <p>(X) Application(s) filed herewith</p> <p>Additional numbers attached? () Yes (X) No</p>
<p>5. Party to whom correspondence concerning document should be mailed:</p> <p>Customer No. 20,995 Address: Knobbe, Martens, Olson & Bear, LLP 2040 Main Street, 14th Floor Irvine, CA 92614 Return Fax: (949) 760-9502 Attorney's Docket No.: SDISW.022AUS</p>	<p>6. Total number of applications and patents involved: 1</p>
<p>7. Total fee (37 CFR 1.21(h)): \$40 (X) Enclosed</p>	<p>8. Deposit account number: 11-1410</p> <p>Please charge this account for any additional fees which may be required, or credit any overpayment to this account.</p>
<p>9. Statement and signature.</p> <p>To the best of my knowledge and belief, the foregoing information is true and correct, and any attached copy is a true copy of the original document.</p> <p><u>Mincheol Kim</u> Name of Person Signing</p> <p> Signature</p> <p><u>6/22/06</u> Date</p> <p>51,306 Registration No.</p> <p>Total number of pages including cover sheet, attachments and document: 3</p>	

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ASSIGNMENT

WHEREAS, I, the undersigned, have invented certain new and useful improvements in an
METHODS OF FABRICATING THIN FILM TRANSISTOR AND ORGANIC LIGHT EMITTING DISPLAY DEVICE USING THE SAME
the specification of which was executed on even date herewith.

AND WHEREAS, **Samsung SDI Co., Ltd.**, (hereinafter "ASSIGNEE"), with its principal place of
business at **575 Shin-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea**, desires to acquire
the entire right, title, and interest in and to the said improvements with respect to the United States of
America, its territories and possessions.

NOW, THEREFORE, in light of good and valuable consideration, the receipt of which is hereby
acknowledged, I, the said inventor, do hereby acknowledge that I have sold, assigned, transferred and set
over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its
successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to
and under the said improvements, and the said application and all provisional applications relating thereto,
and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may
be granted thereon and all reissues and extensions thereof, and all rights of priority under International
Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any
country or countries foreign to the United States, and all Letters Patent which may be granted for said
improvements in any country or countries foreign to the United States and all extensions, renewals and
reissues thereof; and I hereby authorize and request the Commissioner of Patents of the United States, and
any Official of any country or countries foreign to the United States, whose duty it is to issue patents on
applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, its
successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant and agree that we will communicate to the said ASSIGNEE, its
successors, legal representatives and assigns, any facts known to me respecting said improvements, and
testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue
applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its
successors, legal representatives and assigns, to obtain and enforce proper patent protection for said
improvements in all countries.

Date: June 21, 2006

Signature: Eui Hoon Hwang

Name: Eui-Hoon HWANG

Address : c/o Samsung SDI Co., Ltd.

575 Shin-dong, Yeongtong-gu, Suwon-si,

Gyeonggi-do, Republic of Korea

Date: June 21, 2006

Signature: Sang-Ciul Lee

Name: Sang-Ciul LEE

Address: c/o Samsung SDI Co., Ltd.

575 Shin-dong, Yeongtong-gu, Suwon-si.

Gyeonggi-do, Republic of Korea